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(71) 出願人 (米国を除く全ての指定国について): 東京応化工業株式会社 (TOKYO OHKA KOGYO CO., LTD.) [JP/JP]; 〒2110012 神奈川県川崎市中原区中丸 子 1 5 0番地 Kanagawa (JP).

(72) 発明者; および

(75) 発明者/出願人 (米国についてのみ): 岩下 淳 (IWASHITA, Jyun) [JP/JP]; 〒2110012 神奈川県川崎市中原区中丸子 1 5 0番地東京応化工業株式会社内 Kanagawa (JP). 立川 俊和 (TACHIKAWA, Toshikazu) [JP/JP]; 〒2110012 神奈川県川崎市中原区中丸子 1 5 0番地東京応化工業株式会社内 Kanagawa (JP).

(74) 代理人: 酒井 宏明 (SAKAI, Hiroaki); 〒1000013 東京都千代田区霞が関三丁目 2番 6号 東京倶楽部ビルディング 酒井国際特許事務所 Tokyo (JP).

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一 国際調査報告書

2文字コード及び他の略語については、定期発行される 各PCTガゼットの巻頭に掲載されている「コードと略語 のガイダンスノート」を参照。

(54) Title: NEGATIVE RESIST COMPOSITION AND PROCESS FOR FORMATION OF RESIST PATTERNS

(54) 発明の名称: ネガ型レジスト組成物およびレジストパターン形成方法

OH
$$R_4$$

$$R_5$$

$$O$$

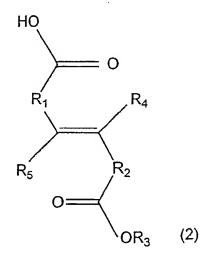
$$R_2$$

$$O$$

$$OR_3$$

$$OR_3$$

$$OR_3$$



(57) Abstract: A negative resist composition containing a polymer comprising as a monomer component one member selected from among dicarboxylic monoesters represented by the general formulae (1) and (2); and a process for formation of resist patterns by using the same: (1) (2) [wherein R_1 and R_2 are each an alkyl chain of 0 to 5 carbon atoms; R_3 is a substituent having at least two alicyclic structures; and R_4 and R_5 are each hydrogen or alkyl of 1 to 8 carbon atoms]. By virtue of the polymer, the composition can form a resist pattern having improved resistances to dry etching and electron beam from a scanning electron microscope (SEM), while the solubility in an alkaline developing solution is maintained.

/結葉右/



(57) 要約:

下記一般式(1)および(2):

$$R_4$$
 R_5
 R_2
 O
 OR_3
 OR_3
 OR_4
 OR_4
 OR_5
 OR_5
 OR_5
 OR_5

HO
$$R_1 \qquad R_4$$

$$R_5 \qquad R_2 \qquad (2)$$

$$OR_3$$

(式中、 R_1 および R_2 は炭素数 $0\sim 5$ のアルキル鎖を表し、 R_3 は少なくとも2以上の脂環式構造を有する置換基を表し、 R_4 および R_5 は水素原子、または炭素数 $1\sim 8$ のアルキル基を表す。)で表されるジカルボン酸モノエステル化合物のいずれか一種をモノマー成分として有する重合体を含むネガ型レジスト組成物及びそれを用いたレジストパターン形成方法。当該重合体を含有することにより、ドライエッチング耐性および走査型電子顕微鏡(SEM)による電子線への耐性が向上するとともにアルカリ現像液に対する溶解性が維持される。

INTERNATIONAL SEARCH REPORT

International application No.

PCT/JP2004/004080

		0007000
A. CLASSIFICATION OF SUBJECT MATTER Int.Cl ⁷ G03F7/038, C08F220/10		
According to International Patent Classification (IPC) or to both nati	ional classification and IPC	
B. FIELDS SEARCHED		
Minimum documentation searched (classification system followed by Int.Cl ⁷ G03F7/038, C08F220/10	y classification symbols)	
	extent that such documents are included in the Jitsuyo Shinan Toroku Koho Toroku Jitsuyo Shinan Koho	fields searched 1996–2004 1994–2004
	<u> </u>	· · · · · · · · · · · · · · · · · · ·
Electronic data base consulted during the international search (name	of data base and, where practicable, search tel	rms used)
C. DOCUMENTS CONSIDERED TO BE RELEVANT		
Category* Citation of document, with indication, where	appropriate, of the relevant passages	Relevant to claim No.
A (DJP 2001-247513 A (Mitsubis) 11 September, 2001 (11.09.0) Full text (Family: none)		1-5
A ②JP 2001-166474 A (JSR Corp 22 June, 2001 (22.06.01), Full text (Family: none)	-),	1-5
A ③JP 2000-284473 A (Fuji Phot 13 October, 2000 (13.10.00) Full text & US 6432615 B1		1-5
Further documents are listed in the continuation of Box C.	See patent family annex.	
Special categories of cited documents: document defining the general state of the art which is not considered to be of particular relevance.	"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention	
"E" earlier application or patent but published on or after the international filing date	"X" document of particular relevance; the cle considered novel or cannot be considered.	
"L" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)	step when the document is taken alone "Y" document of particular relevance; the claimed invention cannot be	
"O" document referring to an oral disclosure, use, exhibition or other means document published prior to the international filing date but later than the priority date claimed	considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art "&" document member of the same patent family	
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Name and mailing address of the ISA/	Authorized officer	
Japanese Patent Office	, -	
Facsimile No. Form PCT/ISA/210 (second sheet) (January 2004)	Telephone No.	TACHMENT F

INTERNATIONAL SEARCH REPORT

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Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
(A)JP 2000-250204 A (Shin-Etsu Chemical Co., Ltd.), 14 September, 2000 (14.09.00), Full text & US 6395453 B1	1-5
⑤JP 2000-206694 A (Tokyo Ohka Kogyo Co., Ltd.), 28 July, 2000 (28.07.00), Full text & US 2001-49073 A1	1,-5
(JJP 2000-75486 A (Siemens AG.), 14 March, 2000 (14.03.00), Full text & EP 957399 A2 & US 6063543 A1	1-5
<pre>JP 2000-56459 A (Fujitsu Ltd.), 25 February, 2000 (25.02.00), Full text (Family: none)</pre>	1-5
©JP 2000-26548 A (Siemens AG.), 25 January, 2000 (25.01.00), Full text & EP 952166 A2 & US 6306990 B1	1-5
	14 September, 2000 (14.09.00), Full text & US 6395453 B1 ⑤ JP 2000-206694 A (Tokyo Ohka Kogyo Co., Ltd.), 28 July, 2000 (28.07.00), Full text & US 2001-49073 A1 ⑥ JP 2000-75486 A (Siemens AG.), 14 March, 2000 (14.03.00), Full text & EP 957399 A2 & US 6063543 A1 ⑦ JP 2000-56459 A (Fujitsu Ltd.), 25 February, 2000 (25.02.00), Full text (Family: none) ⑧ JP 2000-26548 A (Siemens AG.), 25 January, 2000 (25.01.00), Full text